



This Technical Advisory describes an issue which may or may not affect the customer's product

Intel Technical Advisory

TA-1144

5200 NE Elam Young Parkway
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Intel® Server S7200APR Product Family has “Engineering Sample” labels on the boards.

Affected Products- Intel® Server S7200APR Product Family

Product Type	Product Code	MM#
Intel® Server Boards	S7200APR	959387
Intel® Compute Modules	HNS7200APR	959388
	HNS7200APRL	959389
Intel® Server Systems	LAP2304JS795600	977534
	LAP2304JS695600	977750
	LAP2304JS610800	977868
	LAP2304JS650000	978478
	LAP2304JS610000	978479
	LAP2304JS610001	980828
	LAP2304JS650600	981049
	LAP2204JS650000	983485
	LAP2204JS690500	983919
	LAP2204JS650600	984624
	LAP2204JS655200	999D6K
	LAP2204JS695500	999D38
	LAP2204JS655600	999DXZ
	LAP2204JS655601	999F0M

Description

Intel has recently discovered an issue in which an “Engineering Sample” label is present on production boards. The label is mounted on the underside of the boards and is not customer visible without disassembly of the board from the compute module. The label (PBA J47221-251 or greater) that is visible on the top side of the board is the correct production label for Intel® Server Board S7200APR. Below is an example of the engineering sample label on the underside of the board:



Root Cause

Full root cause was determined to be a Build Of Material (BOM) and Standard Operating Procedure (SOP) error when the production boards were built.

Corrective Action

This error has been corrected and current production boards do not have the engineering sample label. The factory SOP has been updated to ensure that this mis-labeling does not occur in the future.

Recommended Customer Action/Work Around

As previously stated, the label is on the underside of the board and is not visible to customers. As previously stated, the production label on the top side of the board is correct. Intel does not recommend any customer action for this issue. The information provided is For Your Information (FYI) only. The issue has no impact to form, fit, function, or performance to the production boards.

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